

Filed:

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE h re Application of

Bojarczuk, et al. Serial No.:

Group Art Unit:

TECHNOLOGY CENTER 2800

ALUMINUM NITRIDE AND ALUMINUM OXIDE/ALUMINUM NITRIDE HETEROSTRUCTURE GATE DIELECTRIC STACK BASED FIELD EFFECT TRANSISTORS AND METHOD FOR FORMING SAME

Honorable Commissioner of Patents Washington, D.C. 20231

09/755,164

January 8, 2001

## AMENDMENT UNDER 37 C.F.R. §1.111

Sir:

In response to the Office Action dated July 3, 2002, please amend the above-identified application as follows:

## IN THE CLAIMS:

Please amend claims 1-7, 11, 15 and 17 as follows:

(Amended) A field effect transistor, comprising:

a substrate comprising a source region, a drain region, and a channel region therebetween; an insulating layer disposed over said channel region, said insulating layer comprising a

layer comprising aluminum nitride and at least one of a layer of aluminum oxide, a layer of

silicon dioxide, and a layer of silicon nitride disposed over said channel region; and a gate electrode disposed over said insulating layer.